

# **FM50** Low Voltage SOT-23 Temperature Sensor

### Features

- Precision Calibrated to ±1°C (Typical)
- Temperature Range: -40°C to 125°C
- Extremely Linear Output Ramp (10mV/°C)
- Output Ramp is Calibrated in Degrees Celsius
- Low Operating Current <130µA (no load)
- Low Self Heating (0.2°C Max in Still Air)
- Operating Voltage Range: +2.7V to 6.0V
- Uses a Single Positive Supply
- Non-linearity  $\leq 0.8^{\circ}$ C

## Applications

- Mobile Phones
- Mobile Communications Terminals
- Computers
- Battery Management
- FAX Machines/Printers/Copiers
- Portable Medical Instruments
- HVAC
- Power Supply Modules
- Disk Drives
- Automotive Control Circuits

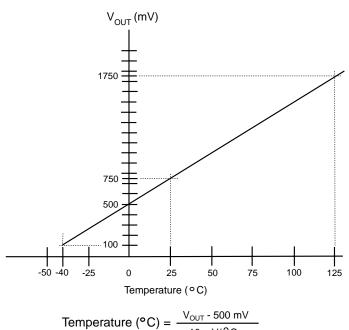
### **Thermal Response**

### Description

As a high-precision CMOS temperature sensor, the FM50 is a cost-effective solution for high-accuracy low-power temperature monitoring applications. Output voltage versus temperature is extremely linear, with a slope of  $10 \text{mV}/^{\circ}\text{C}$ . Typically accuracy is  $\pm 1^{\circ}\text{C}$  over a -40°C to  $125^{\circ}\text{C}$ temperature range and  $\pm 0.5^{\circ}\text{C}$  at room temperature.

No calibration is required. All ports are calibrated during assembly and test.

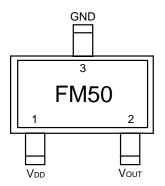
Package is a 3-pin surface mount SOT-23.



10 mV/°C

FM50 Output Voltage vs. Temperature

# **Pin Assignments**



# **Pin Descriptions**

Pin Name	Pin No.	Туре	Function	
Vout	2	Analog Output	<b>Temperature Sense.</b> Analog output voltage indicating temperature. VOUT = 500+10T(°C) mV	
Vdd	1	Power	Supply Voltage. 2.4 to 6.0V	
GND	3	Power	Ground.	

#### Absolute Maximum Ratings<sup>1</sup>

Parameter	Min.	Тур.	Max.	Units
Supply Voltage			+7	V
Output Voltage			VDD + 0.5	V
Output Current			10	μA
Operating Temperature Range <sup>2</sup>	-50		+150	°C
Storage Temperature Range	-60		+150	°C
Lead Soldering Temperature			220	°C
ESD <sup>2</sup> Human Body Model Machine Model			2000 250	V V

Notes:

1. Absolute maximum ratings are limits beyond which operation may cause permanent damage to the device. These are stress ratings only; functional operation at or above these limits is not implied.

2. Operating ratings are conditions for which the device is intended to be functional without specific guaranteed performance limits. For guaranteed specifications and test conditions refer to Electrical Characteristics.

3. Human Body Model: 100pF capacitor discharged through a 1.5kOhm resistor into each pin. Machine Model: 200pF capacitor discharged directly into each pin.

### **Electrical Characteristics**<sup>4</sup>

Limits apply for -40°C  $\leq$  TA  $\leq$  +125°C and VDD = +5.0V unless otherwise noted.

Parameter	Symbol	Conditions	Min	Тур	Мах	Units
Accuracy <sup>5</sup>		TA = +25°C	-1	±0.5	+1	°C
		$T_A = -40^{\circ}C (T_{MIN})$	-3	±1	+3	°C
		T <sub>A</sub> = +125°C (T <sub>MAX</sub> )	-3	±1	+3	°C
Non-Linearity <sup>6</sup>			-0.8		+0.8	°C
Supply Voltage	Vdd		+2.7		+6.0	V
Supply Current	Is	Output floating; TA = +25°C			130	μA
Output Sink Capability	IOL	+2.7V < V <sub>DD</sub> < +6.0V		50		μA
Output Source Capability	ЮН	+2.7V < V <sub>DD</sub> < +6.0V		25		μA
Average Output Slope (Sensor Gain)	AOUT		9.8	10	10.2	mV/°C
Room Temperature Output	VOUT25	T <sub>A</sub> = +25°C	740		760	mv

#### Notes:

4. These specifications are guaranteed only for the test conditions listed.

Accuracy (expressed in °C) = Difference between calculated output voltage and measured output voltage. Calculated output voltage = 10mV/°C multiplied by the device's case temperature at specified conditions of temperature, voltage and power supply, added to 500mV.

6. Non-linearity is defined as the deviation of the output-voltage-versus-temperature curve from the best-fit straight line, over the device's rated temperature range.

#### **Typical Performance Characteristics**

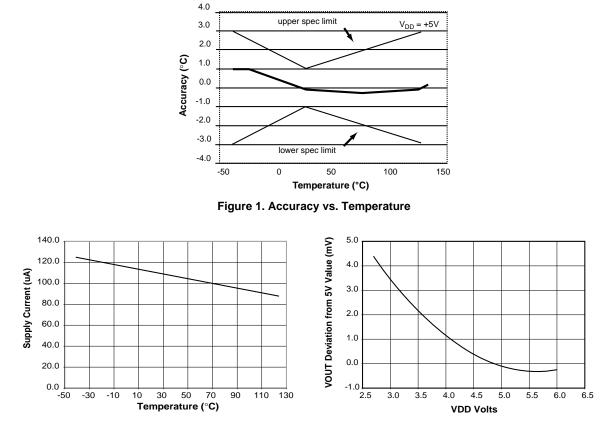
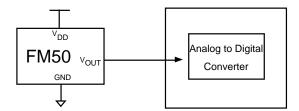


Figure 2. Typical IDD versus Temperature

Figure 3. Typical Sensitivity to Supply Voltage

### **Applications Information**

Application Diagram



#### Mounting

The FM50 can be easily mounted by gluing or cementing it to a surface. In this case, its temperature will be within about 0.2°C of the temperature of the surface it is attached to if the ambient air temperature is almost the same as the surface temperature. If the air temperature is much higher or lower than the surface temperature, the actual temperature of the FM50 die will be at an intermediate temperature between the surface temperature and the air temperature.

To ensure good thermal conductivity, the backside of the FM50 die is directly attached to the GND pin. The lands and traces to the FM50 will, of course, be part of the printed circuit board, which is the object whose temperature is being

measured. These printed circuit board lands and traces will not cause the FM50's temperature to deviate from the desired temperature.

Alternatively, the FM50 can be mounted inside a sealed-end metal tube, and can then be dipped into a bath or screwed into a threaded hole in a tank. As with any IC, the FM50 and accompanying wiring and circuits must be kept insulated and dry to avoid leakage and corrosion. This is especially true if the circuit may operate at cold temperatures where condensation can occur. Printed-circuit coatings and varnishes such as Humiseal and epoxy paint or dips can be used to ensure that moisture cannot corrode the FM50 or its connections.

## **Typical Applications Circuits**

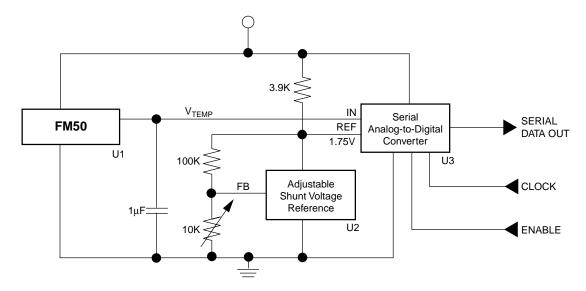


Figure 4. Serial Output Temperature to Digital Converter (Full Scale = +125°C)

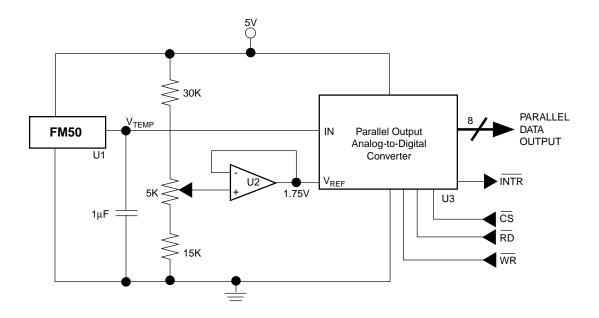


Figure 5. Parallel Output Temperature to Digital Converter (Full Scale = +125°C)

#### **Typical Applications (continued)**

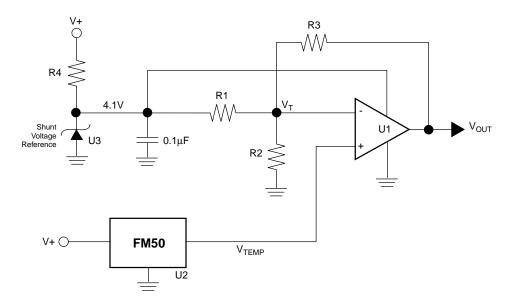
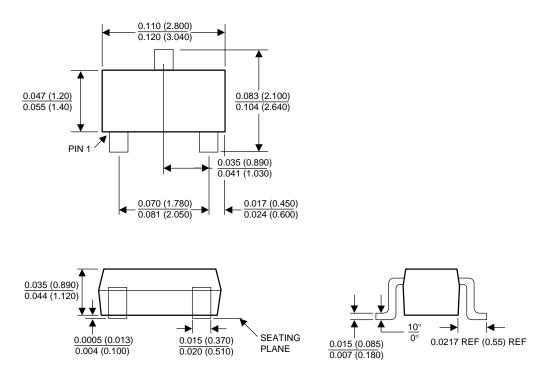


Figure 6. Thermostat/Fan Controller

# Mechanical Dimensions inches (millimeters) unless otherwise noted

#### SOT-23 FS Package Code AU



#### **Ordering Information**

FM50

Part Number	Package	Temperature Range	Shipping
FM50S3X	3-Pin SOT-23	-40°C to +125°C	Tape and Reel, 3000 units/reel

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